

Applications will be accepted from January 17, 2022 (Mon.) 10:00 a.m. (JST)

Organizers Japan Electronics Packaging and Circuits Association, Japan Institute of Electronics Packaging, Japan Robot Association Electronic Device Industry News (Sangyo Times, Inc.), Electric Wire & Cable News (KOGYO TSUSHIN CO., LTD), **Co-organizers** JTB Communication Design, Inc. Japan Federation Of Electronic Parts Distributors And Dealers To Kyo Electronics Appliances Wholesalers Association SENKEN SHIMBUN CO., LTD., Optoelectronics Industry and Technology Development Association Sponsor Ministry of Economy, Trade and Industry

Overseas Cooperation: World Electronic Circuits Council (WECC) Member Associates China Printed Circuit Association (CPCA), European Institute of Printed Circuits (EIPC), Hong Kong Printed Circuit Association (HKPCA), IPC-Association Connecting Electronics Industries (IPC), Indian Printed Circuit Association (IPCA) Electronic Industries Association of India (ELCINA), Korea Printed Circuit Association (KPCA), Thailand Printed Circuit Association (THPCA) Taiwan Printed Circuit Association (TPCA) As of Dec. 15, 2021

Comprehensive exhibition of technology embodying 5G/5G+, automobile, IoT/infrastructure (network, reusable energy, data center, etc.), robots, wearable, advanced optical system, etc.

- Highly specialized and focused
- Exhibition of large attendance from all over the world

Exhibition Outline

Our objective is to offer and propose technical information and contribute to the advancement of the electronic circuit industry and all related fields by presenting exhibitions of new contents and solutions related to the electronic circuits and packaging technologies used in all electronic / information and communication / control equipments, as well as sensors and E-Textiles (wearable technology) which have great potential for widespread use.

Exhibition Period	Wednesday, June 15 to Friday, June 17, 2022, 10:00 a.m 5:00 p.m.
Venue	Tokyo Big Sight East Exhibition Halls 2-6
Managed by	Japan Electronics Packaging and Circuits Association (JPCA)
Secretariat Office	JTB Communication Design, Inc.
Admission	1,000 Yen (including tax) * Free Admission for those who have pre-registered online.

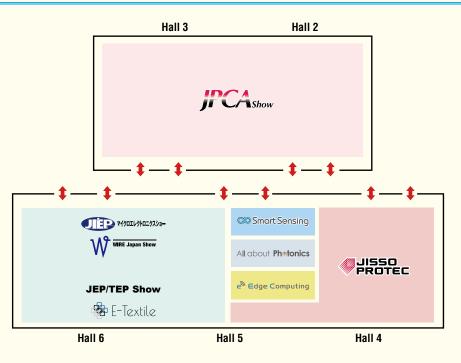
Result of 2021

Venue Tokyo Big Sight South Hall 1-3+Conference Tower Exhibit scale 228 companies / 411 booths Number of visitors 16,699 people

Key points of the 2022 Exhibition!

- (1) Same exhibition floor size as before COVID (over 40,000 sq.m.)
- (2) Exhibitors can choose their own booth (in order of application)
- (3) Strengthen the effect of exhibiting (Webinars, digest of exhibition)
- (4) New SDGs Device Exhibition

Tentative Exhibition Floor Layout



Exhibitions held inside the exhibition/relevant exhibits

Electronic circuits technology

Show 51st International Electronic Circuits Exhibition

- PWB Tech
- Finished Products, Design Technologies, Reliability and Inspection Technologies, Main Materials, Processing Technologies, Materials, and Equipment, Manufacturing Equipment, Environmental Systems, Distribution Systems Module JAPAN
- Module board / Module Board mounting / General technology for built-in parts (Finished Products / Related Products / Design / Reliability inspection / Materials/Functional materials / Related equipment / Related system) Flexible Printed Circuits Products Area
- General technology for Flexible Printed Circuits (Manufacturing)
- BENS Japan
 General contracted services related to EMS, Electronic electrical equipments, and Semiconductors Organizer: Japan Electronics Packaging and Circuits Association

SDGs Materialization Technology

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SDGs Device Shov

· Renewable energy related electronics Power electronics related mounting / materials Power semiconductors / power devices (IGBTs, MOSFETs, Bipolar transistor, etc.), various memories (S-RAM, D-RAM, etc.), semiconductor package, module with built-in parts, metal core printed wiring board. thermal solution, Solar cell batteries, batteries, hydrogen fuel, power electronics, various related devices, etc.

Co-organizers: Japan Electronics Packaging and Circuits Association, Electronic Device Industry News (Sangyo Times, Inc.)

Sensor technology

📖 Smart Sensina Smart Sensing

General technology for Sensor and Sensing System (Sensors, Sensor Nodes, Semiconductors, Parts and Devices, Electronics, Telecommunications Devices, Network Systems, Software, Data Platform, Power Sources, Other Related Devices, Technologies and Services)

Co-organizers: Japan Electronics Packaging and Circuits Association, JTB Communication Design, Inc.

Electrical/optical transmission technology

WIRE Japan Show Electrical /optical transmission technology Exhibiton

General transmission technology for using wire and cable (Industrial equipment / Electrical wire, cable and connector / Electric wire processing machine / Wiring material / Wire Harness / Measuring instrument for electric wire and cable / Various devices + D116 / Inspection technology / M2M transmission / Optical transmission)

Co-organizers: Japan Electronics Packaging and Circuits Association, Cable News (KOGYO TSUSHIN CO., LTD)

High-density packaging technologies

Microelectronics Show

36th ADVANCED ELECTRONICS PACKAGING EXHIBITION

General technology for implementation and electric technology (Materials / Circuit and Mounting design / High speed high frequency / Electromagnetic properties / Electronic parts / mounting / Optical circuit mounting / Environmental affinity implementation / Semiconductor Package / Micro mechatronics mounting technology / Related Manufacturing equipment)

Organizer: Japan Institute of Electronics Packaging

Semiconductors and Electronic parts

JEP/TEP Show

Japan Federation Of Electronic Parts Distributors And Dealers Tokyo Electronics Appliances Wholesalers Association

General technology for solutions by Semiconductors and Electronic parts (Semiconductors / Electronic Devices / Sensors / Mechanical Devices / FA control equipments / Measuring instruments / Power Sources / IoT and M2M Solution / Manufacturing solution system)

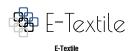
Co-organizers: Japan Federation Of Electronic Parts Distributors And Dealers, Tokyo Electronics Appliances Wholesalers Association





General technology for Electronic Component Packaging Technologies (Electronic component mounting machine / Semiconductor mounting equipment System / nspection technology / Mounting design system / Robots) Organizer: Japan Robot Association

Highly functional textile



A mix e-textile of electronic technology, fiber and clothing (General technology for smart textile, stretchable and wearable (Textile material / Conductive material / material / Knitting / weaving technology / Print marking technology / Films)

Co-organizers: Japan Electronics Packaging and Circuits Association, SENKEN SHIMBUN CO., LTD.

Edge solution technology

e[®] Edge Computing Edge Computing

Advantageous general edge solutions for

communication volume

Unmanned store, etc.

areas such as low delay, high safety and low

[Edge Application Areas] Automatic operation

system / Factory Automation / Telemedicine

/ AR/VR / Smart city / Agritech / FinTech /

Co-organizers: Japan Electronics Packaging and Circuits Association, JTB Communication Design, Inc.

applications / network systems INTERNATIONAL OPTOFLECTRONICS EXHIBITION "ote Cata interOpto

Optical devices for Automotive and in-vehicle . Manufacturing and production systems / Data centers / Long-distance communication / Healthcare and medical optical devices / AV and home appliances

Organizer: Optoelectronics Industry and Technology Development Association (OITDA) Presented by: JTB Communication Design, Inc

All about **Photonics** Optical and next-generation Deep UV / NIR /

LEDs application development

LED JAPAN

I FD JAPAN

inspection / manufacturing equipment / Optical

UV / NIR LEDs / LED package material /

Devices / power sources / Measurement /

component / material / LED application

Co-organizers: Japan Electronics

JTB Communication Design. Inc.

Packaging and Circuits Association,

finished product (automotive lighting, LED

visible light communication, medical lighting)

Image processing / sensing technology

Imaging Japan

Imaging Japan

Various camera / sensor equipments / Image processing equipment / Image recognition / image understanding technology / Instrumentation / measurement technology / I iDAR

Co-organizers: Japan Electronics Packaging and Circuits Association, JTB Communication Design, Inc.

Companies in each field that are expected to participate

Related to automobile:

Aisin Seiki, Asahi Denso, ICHIKOH INDUSTRIES, Calsonic Kansei, Keihin, KOA, KOITO MANUFACTURING, STANLEY ELECTRIC, Sumitomo Wiring Systems, DAIHATSU MOTOR, DENSO, TOKAI RIKA, Toyodenso, TOYOTA MOTOR, NISSAN MOTOR, NHK SPRING, PIONEER, Hitachi Automotive Systems, Hino Motors, SUBARU, Honda Motor, Mazda Motor, MITSUBISHI MOTORS, YAZAKI

OA/Robotics:

OMRON, KEYENCE, Canon, KONICA MINOLTA, CYBERDYNE, SANYO DENKI, JUKI, SEIKO EPSON, Panasonic, Panasonic Smart Factory Solutions, FANUC, FUJI, Fuji Xerox, Mitsubishi Electric, YASKAWA Electric, Yamaha Motor, Ricoh Industry, RICOH JAPAN

Related to information and communication:

Apple, Intel, NHK Media Technology, NTT, NTT DOCOMO, Oki Electric Industry, Korean Broadcasting System (KBS), KYOCERA, KDDI, SoftBank,

TOKYO BROADCASTING SYSTEM HOLDINGS (TBS), Toshiba Information Systems (Japan), IBM Japan, NEC, Microsoft Japan, Nihon Unisys, Panasonic, PFU, Hitachi, Huawei, Fujikura, FUJITSU, Murata Manufacturing

Related to AV and home electrical appliances:

LG Electronics, CASIO COMPUTER, Canon, Samsung Electronics, Sharp, Sony, Sony Global Manufacturing & Operations, Sony Semiconductor Solutions, DAIKIN INDUSTRIES, NIKON, PIONEER, Panasonic, FUJITSU GENERAL, YAMAHA, Roland

Related to medical equipment:

Olympus, Siemens, SHIMADZU, SHIRAKAWA OLYMPUS, Terumo, Canon Medical Systems, Hitachi High-Technologies, Hitachi Healthcare Manufacturing, Fujifilm, MARK ELECTRONICS, MORITA TOKYO MFG

Related to semiconductor device

Intel, STMicroelectronics, Canon, Samsung Electronics, SCREEN Holdings, Sony, TDK, Tokyo Electron, Toshiba Memory, NIKON, Hitachi High-Technologies, FUJITSU SEMICONDUCTOR, Micron Japan, Renesas Electronics, ROHM

Related to aerospace:

IHI, NEC Space Technologies, JAXA (Japan Aerospace Exploration Agency), SINFONIA TECHNOLOGY, Nabtesco, Nippon Avionics, NEC, Mitsubishi Heavy Industries, Mitsubishi Electric

Optical technology:

Dai Nippon Printing Co., Ltd., Toppan Printing CO., LTD., HOYA CORPORATION, Hamamatsu Photonics K.K., Sumitomo Electric Industries, Ltd., Yokogawa Electric Corporation, LIXIL Corporation, Azbil Corporation, NGK ELECTRONICS DEVICES, INC., NTT Electronics Corporation, KAGA ELECTRONICS CO., LTD., JVCKENWOOD Corporation, HP Japan Inc., IHI Inspectation & Instrumentation Co., Ltd., DISCO Corporation, ALPS ALPINE CO., LTD., CANON MEDICAL SYSTEMS CORPORATION, Sony Imaging Products & Solutions Inc., SEKISUI CHEMICAL CO., LTD., SIGMAKOKI CO., LTD., Sharp Fukuyama Laser Co., Ltd., NGK INSULATORS, LTD., Nippon Sheet Glass Co., Ltd.

Other:

Japan Maritime Self-Defense Force, Japan Ground Self-Defense Force, Tokyo Gas, Tokyo Electric Power, Central Japan Railway, WEST JAPAN RAILWAY, East Japan Railway, . Mizuho Bank

Electronic circuit board:

ADVANTEST, Eastern, IBIDEN, ELNA, Kyoei Sangyo, KYOSHA, KYOCERA, Kyoden, Shirai Electronics Industrial, SHINKO, SHINKO ELECTRIC INDUSTRIES, Sumitomo Electric Printed Circuits, DAISHO DENSHI, Nitto Denko, CMK, NIPPON MEKTRON, Panasonic, Hitachi Chemical, Fujikura, FUJITSU INTERCONNECT TECHNOLOGIES, Meiko Electronics Yamashita Materials BISHO KOGYO

Exhibition Fee

Category	1 booth/9m ² *Tax included		
Non-Members	Yen 451,000		
Members	Yen 385,000		

*1 Members of the WECC member associations

(CPCA, EIPC, ELCINA, HKPCA, IPC, IPCA, KPCA, THPCA, TPCA.)

* Size of a booth is $9m^2$ (3m imes 3m).

* Booth construction, cleaning, electricity, water Supply, etc. is not included in the exhibition fee.

How to apply (From January 17, 2022 (Mon.) 10:00 a.m. (JST))

Please apply online on our website. (www.jpcashow.com)

Applications will be accepted from January 17, 2022 (Mon.) 10:00 a.m. (JST).

If you use the Application Form, please apply by e-mail or FAX

Please select the exhibition based on your products, technologies or services and carefully read the "Exhibition Regulations" on the back of the Application Form.

For the exhibition which has the exclusive application form, the relevant exhibition regulations shall be applied.

We will send you an invoice after receiving the Application Form, so please transfer the fee to our account by the due date noted on the invoice (In principle, transfer before the exhibition). The invoice can be downloaded from the exhibitor portal.

Deadline

Friday, March 11, 2022

If all spaces are reserved before the deadline, the application will n longer be accepted.

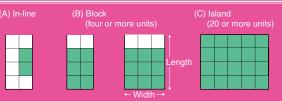
Cancellation charges

If an exhibit is cancelled to suit the exhibitor's circumstances, cancellation charges (full or partial fees) shall apply as below.

Date of receipt of written notice of cancellation	Cancellation charges
Until Friday, March 11, 2022	30% of booth fees
Saturday, March 12 – Wednesday, April 13, 2022	50% of booth fees
Thursday, April 14 – Wednesday, May 11, 2022	70% of booth fees
From Thursday, May 12, 2022 onward	100% of booth fees

Schedule prior to the Exhibition (Tentative)

Booth type



*In some cases, it may not be possible to prepare the requested booth type. *Requests for a corner booth are not accepted.

Assignment of Booth Locations

Booths will be assigned at the Booth Location

Selection Meeting (scheduled for early April, 2022). As a rule, exhibitors will be able to choose their booth locations on a first-come-first-served basis.

Details will be made available in the rules and regulations to be made public from 10:00 a.m. January 17th.

Exhibitor Support Program Option

Promotion services will provide an opportunity to increase your presence at the exhibition.

Package booth

1 booth / basic plan

Price: 82,500 Yen (Tax included)

This plan includes the minimum necessary booth fixtures and fittings, power supply and carpet.



January	March	April	June
January 17 (Fri.) 10:00 – Exhibition application begins	March 11 (Fri.) Exhibitor application deadline Late March Exhibitor Manual available	 Early April Booth Location Selection Meeting Exhibitor's Briefing Early April Sending Invitations Visitor Registration begins 	June 13 (Mon.)-14 (Tues.) Installation period June 15 (Wed.)-17 (Fri.) Exhibition open * Immediate removal on the last day
		Late March onwards Submission of necessary forms	

Safety measures and policies to be taken by organizers

We will take measures to reduce spread of COVID-19 among participants, organizers and other parties involved in the exhibition, and hold the Exhibition with attention to safety. From now on, in consideration of the policies and requests of the Japanese government, relevant ministries and agencies, and local governments, we will plan and implement the exhibition in cooperation and consultation with the facility side.

In the event of cancellation of the Exhibition

If we decide to cancel the Exhibition due to COVID-19, we will refund the total exhibition fee. * For details, please see the Exhibition Regulations.

**Please refer to the following websites for the most recent information.

- > Border enforcement measures to prevent the spread of novel coronavirus (COVID-19) (Ministry of Foreign Affairs of Japan website): https://www.mofa.go.jp/ca/fna/page4e_001053.html
- > Situation Report in Japan (Ministry of Health, Labour and Welfare website): https://www.mhlw.go.jp/stf/covid-19/kokunainohasseijoukyou_00006.html#1-1

Managed by

Secretariat Office

Japan Electronics Packaging and Circuits Association (JPCA)

Kairo Kaikan 2F, 3-12-2, Nishiogikita, Suginami-ku, Tokyo 167-0042 TEL: +81-3-5310-2020 FAX: +81-3-5310-2021 E-mail: show@jpca.org JTB Communication Design, Inc. Celestine Shiba Mitsui Building, 3-23-1, Shiba, Minato-ku, Tokyo, Japan 105-8335 TEL: 81-3-5657-0767 FAX: 81-3-5657-0645 E-mail: jpcashow@jtbcom.co.jp



Deadline

March 11 (Fri.), 2022

MM

YY

Application Form

The Total Solution Exhibition for Electronic Equipment 2022

*June 15-17, 2022 Tokyo Big Sight

Secretariat Office (I/C JTB Communication Design, Inc.) Sent to Celestine Shiba Mitsui Building, 3-23-1, Shiba, Minato-ku, Tokyo, Japan 105-8335 TEL. +81-3-5657-0767 FAX. +81-3-5657-0645

Date:DD

To: Japan Electronics Packaging and Circuits Association

We apply for the exhibition in consent with the "Exhibition Regulations" and "handling of personal information"

(the reverse side of this form). (

[GDPR Notice] https://www.jpcashow.com/show2022/download/GDPR_notice.pdf

Name of Company or Organization					
Applicant	Department	Title		Name	
	Address				
Contact	Zip code		Name		
	TEL		FAX		
	Email				
Co-Exhibitor (Sharing the booth)					
Name of Company or Organization					

◎ If you have any representative in Japan for the 2022 show, please fill-in with their contact information.

Company Name			Contact Person		
Address				Email	
Department	Title			TEL	

Exhibition fees / Booth selection

*See the Exhibition Guide for details.

Non-member		Yen 451,000	× boot	hs	= Yen			
Member	.CINA □ HKPCA □ IPC IPCA □ TPCA	Yen 385,000	× boot	hs	= Yen			
Booth type (see be	elow).	□ (A) In-line □	(B) Block (four or	more booths)	□ (C) Island (20 or more booths)		
(A) In-line (B) Block (four or more booths)	(C) Island (20 or more booths)			Total				
	* Based or	n availability		Yen		(*Tax included)		
The Exhibition you would like to exhibit at and the product to be exhibited (*select only one check box)								
JPCA Show PWB Tech Module Japan Flexible Printed Circuits Products Area EMS Japan	 Exhibited product/Te (* select <u>only one</u> check box) 1. Finished Products 2. Design Technologies 	echnical field	■ Remark	s / Specia	al Reque	est		
Microelectronics Show JISSO PROTEC See Protect	 3. Reliability and Inspection Technologies 							
 SDGs Device Show WIRE Japan Show In order to apply for the following exhibitions, please use the desired application form 	 4. Main Materials 5. Processing Technologies, Materials, and Equipment 			Secreta	riat use only			
the designated application form. Smort Sensing interOpto JEP/TEP Show LED JAPAN [®]	 6. Manufacturing Equipmer 7. Environmental Systems 8. Distribution Systems 	π	Receipt No	Confir	mation by cretariat	Invoice No.		

Mail: jpcashow@jtbcom.co.jp

E-Textile Edge Computing

- 9. Other Imaging Japan

Exhibition Regulations

1. Formation of Contract

Upon receipt of the application form by the Organizer through the online exhibition application system, the contract for this exhibition shall be officially confirmed. JPCA reserves the right to refuse to accept the application. In such cases, JPCA shall not state the reasons for the refusal. (1) Handling of joint application by two or more companies jointly participate in the exhibition In the case that applicants from two or more companies will exhibit jointly, one company shall apply as representative and inform the Organizer at the time of application of the name of the other company and related information.

(2) Refusal of Application for Exhibition Applications will not be accepted from those that are filing for bankruptcy, composition, corporate reorganization, civil rehabilitation or corporate reorganization law procedures, those subject to suspension of current transactions from financial institutions, those engaged in or involved in anti-social activities, or those subject to administrative punishment such as an order to suspend business operations.

In addition, the same shall apply in the event that the organizer deems that the applicant is

equivalent to the above. Even after the confirmation of the contract, if the exhibitor should fall into any of the above, the contract shall be cancelled and the application shall be refused. In this case, any exhibition fees that have already been paid will be fully refunded

The Organizer may conduct investigations and reviews as deemed necessary in connection with

the above

(3) Application by electronic media, facsimile, etc.

In the event an application for exhibition cannot be made through the online exhibition application system due to unavoidable circumstances, an application via electronic media or fax will be accepted. In this case, the Secretariat will input the necessary information into the system on behalf of the applicant.

2. Basic Condition for Accepting Exhibit Application The exhibitors shall agree to the exhibition purposes of JPCA Show 2022, 2022 Microelectronics Show, JISSO PROTEC 2022, SDGs Device Show 2022, WIRE Japan Show 2022 and Smart Sensing 2022 and JEP/TEP Show 2022, E-Textile 2022 are not allowed, in principle, to exhibit products and technologies which are not clearly shown in major target products and technologies for each exhibition described in the exhibition guide.

3. How to Pay Exhibition Fees

The exhibitors shall pay exhibition fees and any optional fees incidental thereto based on the invoice issued by Secretariat Office by the deadline noted on the invoice. The payment from the exhibitors shall be made to the designated bank account described in the invoice in Japanese yen. We don't take promissory notes, checks, etc. The bank transfer fees shall be paid by the exhibitors.

4. Exhibition Booth Fees Include as Follows:

 Booth lease fees
 Partition walls (panels) [in case that there are adjoining booths]
 Other services mandated by the secretariat for exhibitors
 Other expenses concerning visitor services •Safety administrative expenses, expenses of necessary personnel and guard

5. Installation and Removal of Exhibits

The exhibitors must carry in and out decorative articles and exhibits in the booths according to the schedule decided by JPCA.

If an exhibitor needs to carry in or out or move exhibits during the exhibition period, it shall work on these tasks after the approval of JPCA.

6. Use of Exhibition Area

All the advertising and business activities shall be limited in the exhibition booths. Each exhibitor shall have a responsibility to reduce crowdedness because of advertising activities in passages near each booth. Anything such as decorative articles shall not exceed the scope of allocated space.

If JPCA finds any problem with the sound, method of control, materials, or other aspects of decorative articles or exhibits, it shall have the right to prohibit or remove all the acts which go against the purposes of the exhibition.

In the event of exercising the right of the above restriction or removal, JPCA shall not be held liable to reimburse the exhibitors in any way or bear the associated costs.

7. Management of Exhibits and Indemnity

JPCA shall take the greatest possible care to the management and maintenance of the exhibition site, however, it shall not be liable for any loss or damage of exhibits caused by any other reasons.

8. Warranty Clause

(1) The contents such as images, videos, logo marks, various information, etc. posted by the exhibitor in the exhibition space at the exhibition belong to the exhibitor. It will be assumed that the exhibitor has given the organizer permission to publish information on the official website and various printed materials, advertisements, e-mail newsletters, media, etc. related to the exhibition of such content provided by exhibitors to the organizers for public relations activities of the exhibition. (2) The exhibitors shall guarantee JPCA that the exhibits in the exhibition or the related printed materials and other medium concerning the exhibits will not infringe trademark rights, design rights, patent rights, utility model rights or any other intellectual property rights of any third party.

9. Obligation of Exhibitors

(1) In cases where there is a claim that the acts related to the exhibitors' participation in the exhibition infringe trademark rights, design rights, patent rights, utility model rights or any other intellectual property rights of any third party, the exhibitors shall have the obligation to JPCA to promptly settle such dispute with the third party at their own responsibility and not to hinder the complement of amount parts of the ortholized activity of the exhibitors. normal and smooth progress of the exhibition

(2) In cases where a claim regarding the infringement of intellectual property rights occurs against an exhibitor who is a member of the group concerned from the third party, a responsible person for the group exhibitions shall have the same obligation set forth in the preceding paragraph

10. Determination of Booth Location

Booths will be assigned at the Booth Location Selection Meeting (scheduled for early April, 2022). As a rule, exhibitors will be able to chose their booth locations on a first-come-first-served basis. Details will be made available in the rules and regulations to be made public from 10:00 a.m. January 17th.

11. Cancellations of Exhibition Booths and Reduction of Number of Booths If an exhibit is cancelled or the number of exhibition booths is reduced to suit the exhibitor's

circumstances, cancellation charges (full or partial fees) shall apply as below.

Date of receipt of written notice of cancellation (by post, fax, or email)	Cancellation charges		
Until Friday, March 11, 2022	30% of booth fees		
Saturday, March 12 - Wednesday, April 13, 2022	50% of booth fees		
Thursday, April 14 – Wednesday, May 11, 2022	70% of booth fees		
From Thursday, May 12, 2022 onward	100% of booth fees		

12. Prohibition of Subletting, Selling, Transferring, or Exchanging of **Exhibition Space**

The exhibitors shall not sublet, sell, transfer, or exchange exhibition space, either in whole or in part, to any third party, including other exhibitors

13. Notices for Exhibitors of Foreign Products and Foreign Exhibitors (1) Bond procedure for exhibits from foreign countries JPCA shall not apply for bonded exhibition site status. When the exhibitors would like to treat

exhibits from overseas as bonded products, the exhibitors shall complete the bond procedure.

*Be sure to make a copy of the document and keep it for your record.

(2) Obtaining a visa When foreign exhibitors need to obtain visas, the exhibitors shall assume responsibility for preparing the necessary documents including Letter of Guarantee and Letter of Reason for Invitation and complete the procedure.

JPCA shall not issue Letter of Guarantee and Letter of Reason for Invitation to the exhibitors, JPCA shall not be held liable to compensate for losses and/or damages arising from the inability for the exhibitor to participate in the exhibition, in the event the exhibitor are not successful in acquiring a visa

14. Compensation for Damages (1) The exhibitors shall be responsible for all damages to the venue facilities, buildings, or injuries to their personnel owing to negligence on the part of themselves or their agents, or for other reasons.

(2) The exhibitors shall agree to be obliged to make compensation to JPCA for legal costs, liabilities (including an attorney's fee), necessary expenses, and compensation for damages, caused by an action arising out of or as a result of claims in the following cases:

(a) In cases where a lawsuit is filed against JPCA, based on a claim that the acts related to the exhibiters' participation in the exhibition infringe trademark rights, design rights, patent rights, utility model rights or any other intellectual property rights of any third party (including the cases where JPCA as well as the exhibitors are regarded as defendants), or (b) In cases where JPCA is liable for compensation for damages in a judgement, a court, or an out-

of-court settlement due to such a lawsuit in (a), (JPCA shall not be subject to the intension of the exhibitors in terms of a settlement)

(3) JPCA shall bear no responsibility for typographical errors and omissions in sales promotion materials such as announcement advertising and a guide book for the exhibition.

15. Cancellation, suspension, change of Exhibition

(1)The organizer may cancel, suspend, shorten the period of, or change the schedule or venue of the exhibition if the organizer deems it impossible or difficult to hold and continue the exhibition in the event that:

① the land or building used for the venue becomes unavailable, and the organizer deems the land or building inappropriate for use;

2 the organizer deems it not appropriate to hold the exhibition following a request or order for, or a request for consideration of, self-restraint or cancellation of events by the government,

administration or any public agency; or ③ it becomes impossible to hold the exhibition on the occurrence of any event of force majeure, or the organizer deems it not appropriate to hold the exhibition.

(2) The force majeure events described in the preceding paragraph shall mean acts of God, including typhoons, heavy rain, tempests, floods and earthquakes, epidemics, public health risk, delay or suspension of service of public transportation systems, war, civil war, terrorist attacks, strikes and other causes not attributable to the organizer. (3) In no event shall the applicant claim compensation against the organizer for any damages

caused to the exhibitor resulting from any decision made by the organizer. In addition, the organizer shall not be liable for any damages, increased expenses or other unfavorable circumstances

caused to the exhibitor as a result of any such decision. (4) If the organizer decides to cancel or suspend the exhibition prior to or after the start of the exhibition period, exhibition fee will be refunded after deducting a reasonable amount of expenses incurred up to that time. (5) In the event the exhibition fee has already been paid in accordance with (4), fees will be

refunded after deducting the expenses incurred up to that time from the paid amount. In the event of an unpaid payment, the invoice for the exhibition fee shall be disregarded and a new invoice shall be issued for the expenses incurred. Exhibitors shall transfer payment of the exhibition fees in Japanese yen to the bank account designated below by the date listed on the invoice. (6) Regarding the 2021 Exhibition, notwithstanding the above, if the exhibition is cancelled due to the novel coronavirus (COVID-19), the exhibition fee will be fully refunded.

16. Compliance with Provisions

The exhibitors shall comply with the set of provisions stipulated by JPCA.

17. Changes and Additions of Regulations If any question arises regarding any matter not stipulated in the regulations or any provision hereof, the exhibitors shall abide by the decisions of JPCA. JPCA shall reserve the right to make revision and/or supplement to this regulations with the notification to the exhibitors in each fiscal year in advance

18. Governing Law

The contract shall be governed by the laws of Japan.

19. Agreement Jurisdictional Court

It is agreed that the court of jurisdiction for all disputes arising with regards to the contract shall be the Tokyo District Court.

[For the handling of personal information] Japan Electronics Packaging and Circuits Association shall handle customers' personal infor-mation and ensure to protect such information, based on "Act on the Protection of Personal Information" and JPCA's "Personal Information Protection Policy" (http://jpca.jpcontactus/pri-vanue and the supersonal information Protection Policy" (http://jpca.jpcontactus/pri-vanue and the supersonal information Protection Policy" (http://jpca.jpcontactus/pri-tactus/private/p vacy/). The customers shall provide personal information after acknowledging this in advance.
 Your personal information shall be used for communication regarding the exhibition.
 Collected personal information shall not be provided to third parties.

- JPCA entrusts the handling of personal data to JTB Communication Design, Inc. with which JPCA has signed beforehand a non-disclosure agreement, in order to ensure smooth operation of the exhibition.

If an individual requests disclosure of, correction of, addition to or deletion of the personal information he or she has provided, notification of purpose of use, termination of use, erasure of the personal Information, and cessation of supply of such personal data to a third party, JPCA shall promptly cope with such requests.

Please contact the personal information protection manager to which the JPCA is entrusted. Hirohisa Hasegawa (Mr.)

General Manager, Tradeshow Business Unit, Co-Creation Department, JTB Communication Design, Inc. Contact: +81-3-5657-0623

- Personal information provided to JPCA is done so at the discretion of the customers. If you fail to provide necessary personal data, each service, etc. may not be provided to you in an appropriate manner

No methods that are difficult for you to be aware of shall not be used to acquire personal information.

If you have any questions, please contact the below.

Managed by:

Japan Electronics Packaging and Circuits Association

Kairo Kaikan 2F, 3-12-2, Nishiogikita, Suginami-ku, Tokyo 167-0042 Japan Phone: +81-3-5310-2020 Fax: +81-3-5310-2021 E-mail: show@jpca.org

Secretariat Office (I/C JTB Communication Design, Inc.)

Celestine Shiba Mitsui Building, 3-23-1, Shiba, Minato-ku, Tokyo, Japan 105-8335 Tel: +81-3-5657-0767 Mail: jpcashow@jtbcom.co.jp